

Size $10.4 \times 10.4 \times 3.0$ (mm)

Series/Type: B82464G2 Date: March 2008

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Size $10.4 \times 10.4 \times 3.0$ (mm)

<u>SMD</u>

Rated inductance 0.82 μ H to 330 μ H Rated current 0.41 A to 6.2 A

Construction

- Ferrite core
- Magnetically shielded
- Winding: enamel copper wire
- Winding welded to terminals

Features

- Temperature range up to 150 °C
- High rated current
- Low DC resistance
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020C
- Qualified to AEC-Q200
- RoHS-compatible

Applications

- Filtering of supply voltages
- Coupling, decoupling
- DC/DC converters
- Automotive electronics
- Industrial electronics
- Consumer electronics

Terminals

- Base material CuFe2P
- Layer composition Ag, Sn (lead-free)
- Electro-plated

Marking

- Marking on component: Manufacturer, L value (nH, coded), L tolerance (coded), manufacturing date (YWWD), two last digits of work order
- Minimum data on reel: Manufacturer, ordering code, L value, quantity, date of packing

Delivery mode and packing unit

- 16-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 1250 pcs./reel







B82464G2

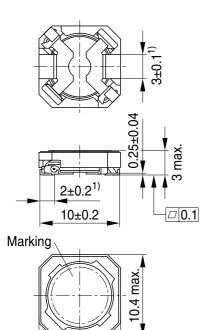


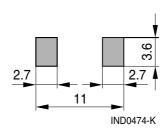
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Dimensional drawing and layout recommendation





Dimensions in mm

1) Soldering area

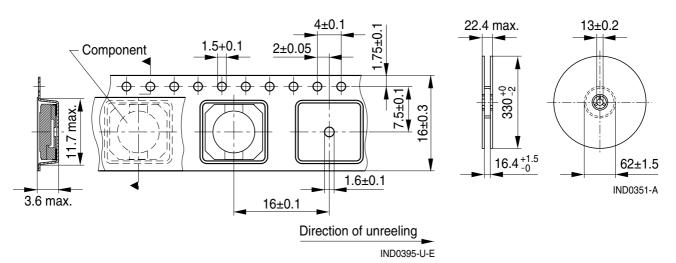
IND0475-W-E

Taping and packing

10.4 max.

Blister tape

Reel



Dimensions in mm

Please read *Cautions and warnings* and *Important notes* at the end of this document.



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Technical data and measuring conditions

| Rated inductance L _R | Measured with impedance analyzer Agilent 4294A at frequency f_L , 0.1 V, 20 °C | | | |
|----------------------------------|--|--|--|--|
| Rated temperature T _B | 85 °C | | | |
| Rated current I _R | Max. permissible DC with temperature increase of \leq 40 K at rated temperature | | | |
| Saturation current Isat | Max. permissible DC with inductance decrease $\Delta L/L_0$ of approx. 10% | | | |
| DC resistance R _{max} | Measured at 20 °C | | | |
| Solderability (lead-free) | Dip and look method Sn95.5Ag3.8Cu0.7: (245 \pm 5) °C, (5 \pm 0.3) s Wetting of soldering area \geq 90% (based on IEC 60068-2-58) | | | |
| Resistance to soldering heat | 260 °C, 40 s (as referenced in JEDEC J-STD 020C) | | | |
| Climatic category | 55/150/56 (to IEC 60068-1) | | | |
| Storage conditions | Mounted: -55 °C +150 °C Packaged: -25 °C +40 °C, ≤ 75% RH | | | |
| Weight | Approx. 2 g | | | |

Characteristics and ordering codes

| L _R | Tolerance | fL | I _R | I _{sat} | R _{max} | Ordering code |
|----------------|-----------|-----|----------------|------------------|------------------|-----------------|
| μH | | MHz | А | А | Ω | |
| 0.82 | ±20% ≙ M | 0.1 | 6.20 | 7.50 | 0.0075 | B82464G2821M000 |
| 1.2 | | 0.1 | 5.60 | 6.80 | 0.009 | B82464G2122M000 |
| 2.0 | | 0.1 | 4.50 | 5.40 | 0.014 | B82464G2202M000 |
| 2.7 | | 0.1 | 3.85 | 4.25 | 0.019 | B82464G2272M000 |
| 3.9 | | 0.1 | 3.45 | 3.45 | 0.027 | B82464G2392M000 |
| 4.7 | | 0.1 | 3.10 | 3.10 | 0.033 | B82464G2472M000 |
| 7.5 | | 0.1 | 2.60 | 2.65 | 0.047 | B82464G2752M000 |
| 10 | | 0.1 | 2.25 | 2.25 | 0.062 | B82464G2103M000 |
| 15 | | 0.1 | 1.80 | 1.85 | 0.090 | B82464G2153M000 |
| 22 | | 0.1 | 1.50 | 1.52 | 0.130 | B82464G2223M000 |
| 33 | | 0.1 | 1.20 | 1.25 | 0.195 | B82464G2333M000 |
| 47 | | 0.1 | 1.12 | 1.10 | 0.235 | B82464G2473M000 |
| 68 | | 0.1 | 0.91 | 0.88 | 0.370 | B82464G2683M000 |
| 100 | | 0.1 | 0.75 | 0.73 | 0.530 | B82464G2104M000 |
| 150 | | 0.1 | 0.61 | 0.59 | 0.840 | B82464G2154M000 |
| 220 | | 0.1 | 0.50 | 0.49 | 1.2 | B82464G2224M000 |
| 330 | | 0.1 | 0.41 | 0.40 | 1.6 | B82464G2334M000 |

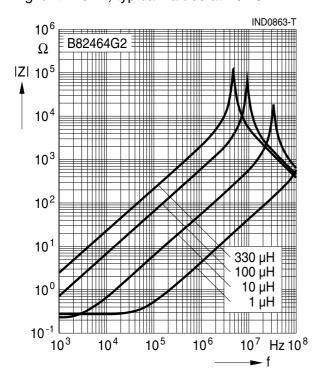


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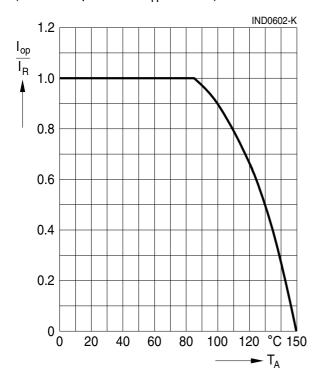
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Impedance |Z| versus frequency f

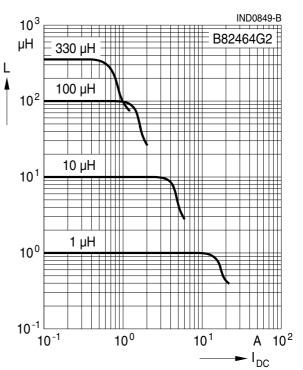
measured with impedance analyzer Agilent 4294A, typical values at 20 °C



Current derating I_{op}/I_R versus ambient temperature T_A (rated temperature $T_R = 85 \text{ °C}$)



Inductance L versus DC load current I_{DC} measured with LCR meter Agilent 4275A, typical values at 20 °C





Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



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